

T_J max.

Package

Diode variations

Vishay General Semiconductor

Surface Mount Schottky Barrier Rectifier



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V_{RRM}	100 V			
I _{FSM}	40 A			
V _F at I _F = 1.0 A (T _A = 125 °C)	0.57 V			

175 °C

DO-219AB (SMF)

Single die

FEATURES

- Low profile package
- Ideal for automated placement
- · Low forward voltage drop, low power losses

Low leakage current

ROHS COMPLIANT HALOGEN FREE

- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: DO-219AB (SMF)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	SS1FH10	UNIT	
Device marking code		110		
Maximum repetitive peak reverse voltage	V _{RRM}	100	V	
Maximum average forward rectified current (fig. 1)	I _{F(AV)} (1)	1.0	Α	
Non-repetitive peak forward surge current 8.3 ms single half sine-wave at $T_{J (init)} = 25 ^{\circ}\text{C}$	I _{FSM}	40	Α	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175	°C	

Note

⁽¹⁾ Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 0.5 A	T _A = 25 °C		0.65	-	V
	I _F = 1.0 A		V _F ⁽¹⁾	0.72	0.80	
	I _F = 0.5 A	T _A = 125 °C	VF (')	0.51	-	
	I _F = 1.0 A			0.57	0.65	
Reverse current	V 100 V	T _A = 25 °C	I _R ⁽²⁾	-	5	
	$V_{R} = 100 \text{ V}$	T _A = 125 °C	IR (-)	65	160	μΑ
Typical junction capacitance	4.0 V, 1 MHz		CJ	70	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width $\leq 5 \text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)				
PARAMETER	SYMBOL SS1FH10			
Typical thermal resistance	R ₀ JA (1)(2)(3)	125	°C/W	
	R _{0JM} (2)(3)	26		

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Device mounted on FR4 PCB, 2 oz. standard footprint

 $^{(3)}$ Thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SS1FH10-M3/H	0.015	Н	3000	7" diameter plastic tape and reel
SS1FH10-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
SS1FH10HM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel
SS1FH10HM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

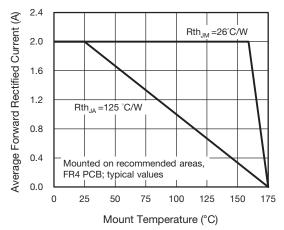


Fig. 1 - Typical Forward Current Derating Curve

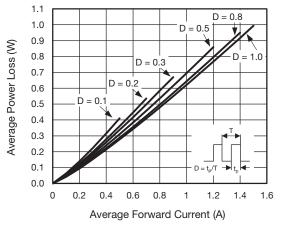


Fig. 2 - Forward Power Loss Characteristics

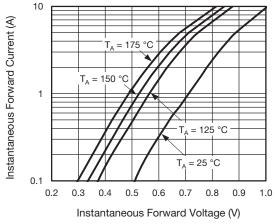


Fig. 3 - Typical Instantaneous Forward Characteristics

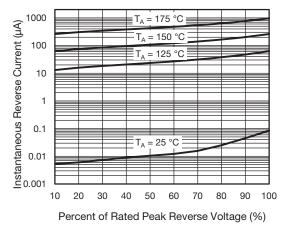


Fig. 4 - Typical Reverse Leakage Characteristics

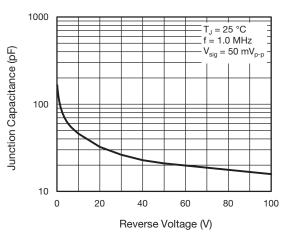


Fig. 5 - Typical Junction Capacitance

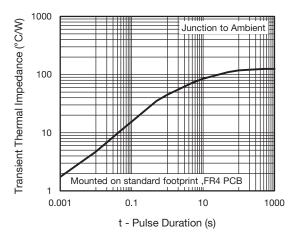
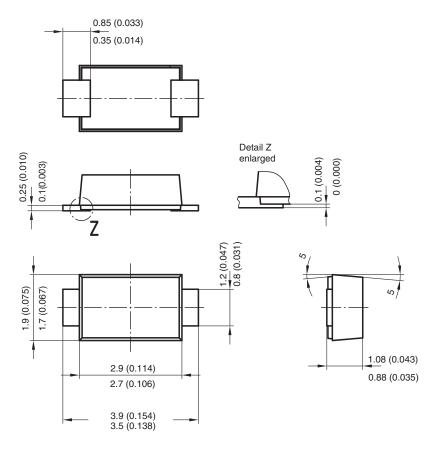


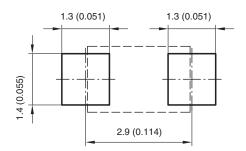
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:

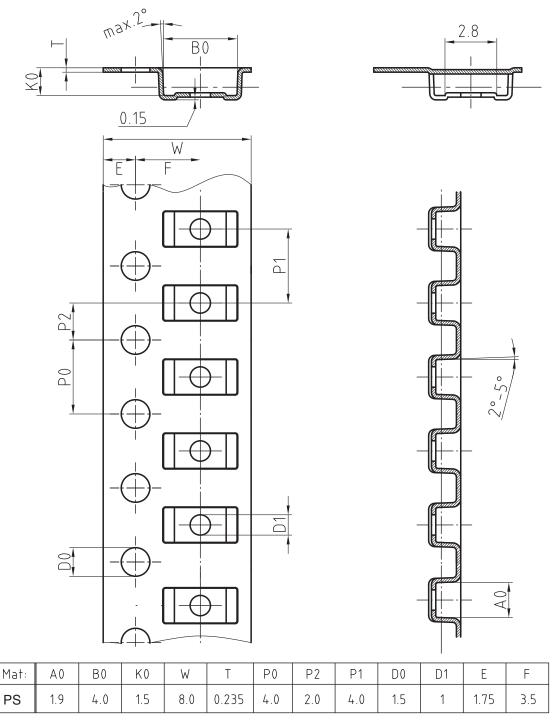


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BLISTERTAPE DIMENSIONS in millimeters: **DO-219AB (SMF)**



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